

**Elektrische Eigenschaften / Electrical properties**

**Charakteristische Werte / Characteristic values**

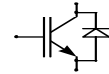
		min.	typ.	max.			
Modulinduktivität stray inductance module		$L_{\text{GCE}}$	-	-	100 nH		
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	$T_C = 25^\circ\text{C}$	$R_{\text{CC}'+\text{EE}'}$	-	7	- mΩ		
<b>Diode Wechselrichter/ Diode Inverter</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Durchlaßspannung forward voltage	$V_{\text{GE}} = 0\text{V}, T_{\text{vj}} = 25^\circ\text{C}, I_{\text{F}} = 50\text{A}$ $V_{\text{GE}} = 0\text{V}, T_{\text{vj}} = 125^\circ\text{C}, I_{\text{F}} = 50\text{A}$	$V_{\text{F}}$	-	1,25	1,7	V	
Rückstromspitze peak reverse recovery current	$I_{\text{F}}=I_{\text{Nenn}}, -di_{\text{F}}/dt = 1150\text{A}/\mu\text{s}$ $V_{\text{GE}} = -10\text{V}, T_{\text{vj}} = 25^\circ\text{C}, V_{\text{R}} = 300\text{V}$ $V_{\text{GE}} = -10\text{V}, T_{\text{vj}} = 125^\circ\text{C}, V_{\text{R}} = 300\text{V}$	$I_{\text{RM}}$	-	35	-	A	
Sperrverzögerungsladung recovered charge	$I_{\text{F}}=I_{\text{Nenn}}, -di_{\text{F}}/dt = 1150\text{A}/\mu\text{s}$ $V_{\text{GE}} = -10\text{V}, T_{\text{vj}} = 25^\circ\text{C}, V_{\text{R}} = 300\text{V}$ $V_{\text{GE}} = -10\text{V}, T_{\text{vj}} = 125^\circ\text{C}, V_{\text{R}} = 300\text{V}$	$Q_{\text{r}}$	-	3,4	-	μAs	
Abschaltenergie pro Puls reverse recovery energy	$I_{\text{F}}=I_{\text{Nenn}}, -di_{\text{F}}/dt = 1150\text{A}/\mu\text{s}$ $V_{\text{GE}} = -10\text{V}, T_{\text{vj}} = 25^\circ\text{C}, V_{\text{R}} = 300\text{V}$ $V_{\text{GE}} = -10\text{V}, T_{\text{vj}} = 125^\circ\text{C}, V_{\text{R}} = 300\text{V}$	$E_{\text{RO}}$	-	0,8	-	mWs	
<b>Transistor Brems-Chopper/ Transistor Brake-Chopper</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$V_{\text{GE}} = 15\text{V}, T_{\text{vj}} = 25^\circ\text{C}, I_{\text{C}} = 25,0\text{A}$ $V_{\text{GE}} = 15\text{V}, T_{\text{vj}} = 125^\circ\text{C}, I_{\text{C}} = 25,0\text{A}$	$V_{\text{CE sat}}$	-	2,2	2,75	V	
Gate-Schwellenspannung gate threshold voltage	$V_{\text{CE}} = V_{\text{GE}}, T_{\text{vj}} = 25^\circ\text{C}, I_{\text{C}} = 0,5\text{mA}$	$V_{\text{GE(TO)}}$	4,5	5,5	6,5	V	
Eingangskapazität input capacitance	$f = 1\text{MHz}, T_{\text{vj}} = 25^\circ\text{C}$ $V_{\text{CE}} = 25\text{V}, V_{\text{GE}} = 0\text{V}$	$C_{\text{ies}}$	-	1,1	-	nF	
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{\text{GE}} = 0\text{V}, T_{\text{vj}} = 25^\circ\text{C}, V_{\text{CE}} = 600\text{V}$ $V_{\text{GE}} = 0\text{V}, T_{\text{vj}} = 125^\circ\text{C}, V_{\text{CE}} = 600\text{V}$	$I_{\text{CES}}$	-	0,7	500	μA	
Gate-Emitter Reststrom gate-emitter leakage current	$V_{\text{CE}} = 0\text{V}, V_{\text{GE}} = 20\text{V}, T_{\text{vj}} = 25^\circ\text{C}$	$I_{\text{GES}}$	-	-	300	nA	
<b>Diode Brems-Chopper/ Diode Brake-Chopper</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Durchlaßspannung forward voltage	$T_{\text{vj}} = 25^\circ\text{C}, I_{\text{F}} = 25,0\text{A}$ $T_{\text{vj}} = 125^\circ\text{C}, I_{\text{F}} = 25,0\text{A}$	$V_{\text{F}}$	-	1,6	2,05	V	
<b>NTC-Widerstand/ NTC-Thermistor</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Nennwiderstand rated resistance	$T_C = 25^\circ\text{C}$	$R_{25}$	-	5	-	kΩ	
Abweichung von $R_{100}$ deviation of $R_{100}$	$T_C = 100^\circ\text{C}, R_{100} = 493\ \Omega$	$\Delta R/R$	-5		5	%	
Verlustleistung power dissipation	$T_C = 25^\circ\text{C}$	$P_{25}$			20	mW	
B-Wert B-value	$R_2 = R_1 \exp [B(1/T_2 - 1/T_1)]$	$B_{25/50}$		3375		K	

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM50GP60

eupec



### Thermische Eigenschaften / Thermal properties

		min.	typ.	max.		
Innerer Wärmewiderstand thermal resistance, junction to case	Gleicher. Diode/ Rectif. Diode	$R_{thJC}$	-	-	1	K/W
	Trans. Wechr./ Trans. Inverter		-	-	0,5	K/W
	Diode Wechr./ Diode Inverter		-	-	0,8	K/W
	Trans. Bremse/ Trans. Brake		-	-	1	K/W
	Diode Bremse/ Diode Brake		-	-	2,3	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	Gleicher. Diode/ Rectif. Diode	$R_{thCK}$	-	0,08	-	K/W
	Trans. Wechr./ Trans. Inverter		-	0,04	-	K/W
	Diode Wechr./ Diode Inverter		-	0,08	-	K/W
Höchstzulässige Sperrschichttemperatur maximum junction temperature		$T_{vj}$	-	-	150	°C
Betriebstemperatur operation temperature		$T_{op}$	-40	-	125	°C
Lagertemperatur storage temperature		$T_{stg}$	-40	-	125	°C

### Mechanische Eigenschaften / Mechanical properties

Innere Isolation internal insulation				$Al_2O_3$	
CTI comperative tracking index				225	
Anzugsdrehmoment f. mech. Befestigung mounting torque		M		3 ±10%	Nm
Gewicht weight		G		180	g